SPECIFICATION



OF

LIQUID CRYSTAL DISPLAY MODULE

Model version:	<u>ASH-8366M</u> 0			
Document Revision:	2			
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Revision record							
Document Revision	Model No. Version No.	Description	Revision by				
0	UMSH-8366MD-T Version No. 0	3.5"TFT.	Ken Lin Jeffry Chen 30-Sep-2009				
1	UMSH-8366MD-T Version No. 0	Modify the Back-light only Specification.	Jenny Huang Jeffry Chen 28-Jul-2012				
2	UMSH-8366MD-T Version No. 0	Modify the packing mode.	Design Section 05-Dec-2018				
U.R	.T. Revision 2	; UMSH-8366MD-T Ver. 0 ; December-05-2018	Page: 2				

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1. BASIC SPECIFICATION

1.1 Mechanical specifications

Items	Nominal Dimension	Unit
Active screen size	3.5" diagonal	-
Dot Matrix	320 * RGB *240	Pixel
Module Size (W x H x T)	76.9 x 63.9 x 3.955	mm.
Active Area (W x H)	70.08 x 52.56	mm.
Dot Pitch (W x H)	0.219 x 0.219	mm.
Color depth	262K	color
Interface	8-bits serial/24-bits parallel RGB / CCIR601/656	-
Driving IC Package	COG	-
Module Weight	35±10%	5 0

^{*} The maximum color depth of this driver IC is 262K colors ,not 16.7M.

1.2 Display specification

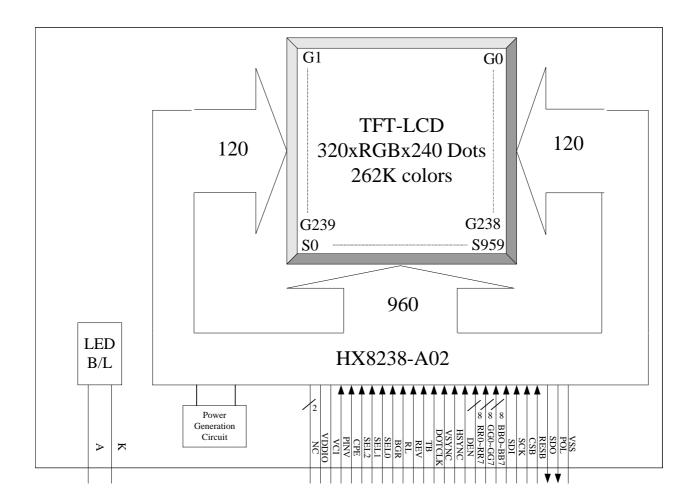
Display	Descriptions	Note
LCD Type	a-Si TFT	-
LCD Mode	TN / Normal white	-
Polarizer Mode	Transmissive	-
Polarizer Surface	Normal	-
Pixel arrangement	RGB-stripe	
Backlight Type	LED	-
Viewing Direction(Gray inversion)	6 O'clock Direction	-

Color tone is slightly changed by temperature and driving voltage.

Note 1: The viewing direction defined in this specification is according to the rubbing direction of its TFT surface treatment by the TFT glass manufacturer. The grayscale inversion is at this direction as well. However, the optimal viewing direction for human view is normally where the color does NOT change to grayscale inversion, and this would be the opposite site of the specified viewing direction in this specification. In any case we advise customers to judge by themselves, and be aware of this phenomenon.

1.3 Outline dimension UMSH-8366MD-T U.R.T. No.XXXXXX-XXXX 22.5±0.15 24.5±0.05(P0.5X49) PRINT DETAIL 3.955±0.5 CONDUCTOR 1.0(MAX) (COMPONENT HEIGHT) STIFFENER DOTS DETAIL 0.3±0.05 RGBR GBR GBR 2.0±0.5 3.56±0.5 0.0828 0.0876 0.258 1.0(MIN) (UNBENDING AREA) 0.258 G238 9 **S959** 8. CONSTANT CURRENT IF=40.0mA; VLED=19.8V(Typ) ⑤ 9. THE MINIMUM BENDING RADIUS (INNER) OF THE FPC IS 0.5mm. 10. "⑥" URT REQUEST PROPERTIES 11. 為私。 SPECIAL PROPERTIES 22.65(MAX) 7.65(MIN) VIEWING | DIRECTION 320xRGBx240 DOTS (ssa)ı 72.9(BEZEL WINDOW) 1. LCD : TFT TRANSMISSIVE MODE,NORMAL WHITE 2. VIEWING DIRECTION : 6 O'CLOCK AME, 3. Top : -30~85'C , Tst : -40~90°C 4. DRIVER IC : HX8238-A02 5. RoHS-COMPLIANT 70.08(A.A) TOLERANCE FOR NOT ASSIGNED : ±0.2 mm 7. LED COLOR: WHITE, 12PCS DICE 1.0(MIN) (UNBENDING AREA) 52.56(A.A) 3.27±0.5 55.4(BEZEL WINDOW) 2.05±0.5 63.9±0.3 27.45±0.5 **U.R.T.** Page: Revision 2; UMSH-8366MD-T Ver. 0; December-05-2018 5

1.4 Block diagram:



Page:

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1.5 Interface pin:

Pin No.	Pin Name	I/O	Description
1	VSS	P	System ground pin of the IC Connect to system ground
2	POL	О	Polarity signal to monitor VCOM signal Leave it OPEN.
3	SDO	o	Data output pin in serial mode Leave it OPEN when not used
4	RESB	I	System reset pin. Internal pull high.
5	CSB	I	Chip select pin of serial interface. Internal pull high Leave it OPEN when not used.
6	SCK	I	Clock pin of serial interface. Internal pull high Leave it OPEN when not used
7	SDI	I	Data input pin in serial mode. Internal pull high Leave it OPEN when not used
8~31	BB [0:7] GG [0:7] RR [0:7]	I	Graphic Data Input Pins. Internal pull low. - RR [0:7]: Red Data - 8-bits - GG [0:7]: Green Data - 8-bits - BB [0:7]: Blue Data - 8-bits For 8 bit interface, only RR[0:7] are used. For unused pins, please connect to VSS or floating.
32	DEN	I	Display enable pin from controller. Connect to VDDIO or floating if not used.
33	HSYNC	I	Line synchronization signal. Internal pull high Fixed to VDDIO or floating if not used
34	VSYNC	I	Frame synchronization signal. Internal pull high Fixed to VDDIO or floating if not used.
35	DOTCLK	I	Dot-clock signal and oscillator source.

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Pin No.	Pin Name	I/O		Description						
				Input pin to select the Gate driver scan direction.						
36	ТВ	I				or Gate scan from G239 to G0	` ′			
						O for Gate scan from G0 to G2	239 (normal sca	m)		
			Input pin to select the display reversion.							
27	DEST	_				O mapping data '0' to maximu	m pixel voltage	for		
3 7	REV	I	norma	•	•			_		
			1		VSS f ck pan	or mapping data '0' to minim el	un pixel voltag	e for		
			Input 1	oin to s	select tl	he Source driver data shift dire	ection.			
38	\mathbf{RL}	I	- Conr	ect to	VDDI	O for display first RGB data a	t S0-S2.			
			- Conr	ect to	VSS fo	or display first RGB data at S9	59-S957.			
			Input pin to select the color mapping.							
39	BGR	I	- Connect to VDDIO for Blue-Green-Red mapping. - Connect to VSS for Red-Green-Blue mapping.							
			Input 1	oin to s	select i	nput interface mode.				
			SEL2	SEL1	SELO	Format	Operating			
							Frequency			
			0			Parallel-RGB data format (only support stripe type color filter)	7.5MHz			
10.42	SEL0~2	_	0	0	1	Serial-RGB data format	19.5MHz			
40~42	SELU~Z	I	0	1	0	CCIR 656 data format (640RGB)	24.54MHz			
			0	1	1	CCIR 656 data format (720RGB)	27MHz			
			1	0	0	YUV mode A data format (Cr-Y-Cb-Y)	24.54MHz	7 I		
			1	0	1	YUV mode A data format (Cr-Y-Cb-Y)	27MHz	 		
			1	1	0	YUV mode B data format (Cb-Y-Cr-Y)	27MHz	1 		
			1	1	1	YUV mode B data format (Cb-Y-Cr-Y)	24.54MHz			

Pin No.	Pin Name	I/O	Description
43	СРЕ	I	Input pin to enable internal charge pump circuit. Internal pull high. - Connect to VDDIO to enable internal charge pump. - Connect to VSS to disable internal charge pump
44	PINV	I	Control the polarity of POL signal. Internal pull low. - Connect to VDDIO, POL phase is reversed with internal VCOM signal. - Connect to VSS, POL phase is same with internal VCOM signal.
45	VCI	P	Power Supply for Analog Circuits.
46	VDDIO	P	Voltage input pin for I/O logic.
4 7	NC	-	No connection.
48	NC	-	No connection.
49	K	P	Backlight LED's cathode.
50	A	P	Backlight LED's anode.

2. ELECTRICAL CHARACTERISTICS

2.1 Absolute Maximum Ratings

Items	Symbol	Min.	Max.	Unit
Input voltage	VCI	VSS-0.3	5.0	V
Supply Voltage	VDDIO	VSS-0.3	4.0	V
Operate temperature range	ТОР	-30	85	°C
Storage temperature range	TST	-40	90	c

2.2 DC Characteristics

Items	Symbol	Min.	Тур.	Max.	Unit	Condition
Power supply voltage	VCI	2.5	3.3	3.6	V	
Power supply pin of IO pins	VDDIO	1.4	3.3	3.6	V	
Current consumption	Ivci+Ivddio	-	-	16	mA	NOTE
Dot Clock	DCK	-	7.5	10	MHz	
Serial Clock	XSCK	-	19.5	30	MHz	

NOTE: The method to illuminate the LCD panel is using the 2-4-7 commend under the measuring condition.

Measuring Condition:

Standard Value MAX.

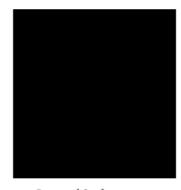
Ta = 25°C

 $V_{CI} = 3.3V$

VDDIO = 3.3V

Dot Clock = 7.5MHz

Display Patten



0 gray black pattern

2.3 Back-light only Specification

Parameter	Symbol	Min	Тур	Max	Unit	Test Condition	Note
Supply Current	If	-	40	-	mA	Ta=25°C	-
Supply Voltage	VF	16.2	19.8	21.6	V	Ta=25°C	-
Half-Life Time	Lf	-	30000	-	hrs	Ta=25°C	-

Note: The "Half-Life Time" is defined as the LED chip brightness decreases to 50% than original brightness, Based on Ta 25±2°C,60±10% RH condition.

2.4 AC Characteristics

2.4.1 8-bits serial/24-bits parallel RGB

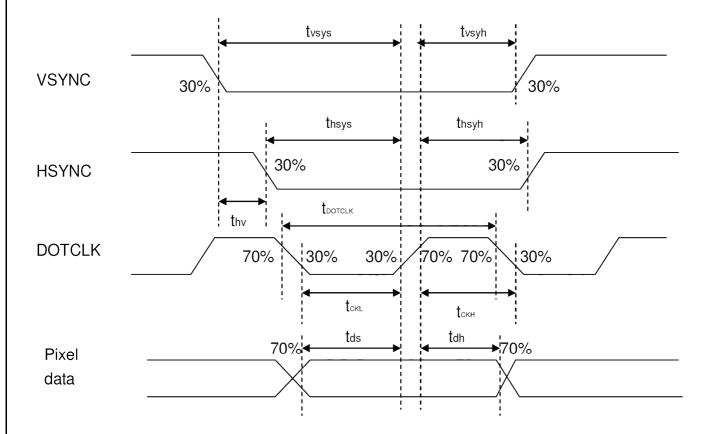


Figure 13. 1Pixel Timing

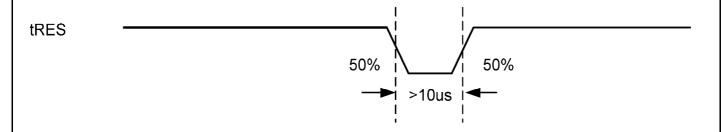
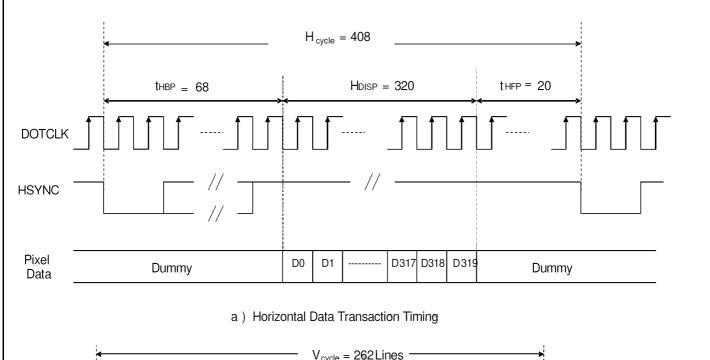


Figure 13. 2 tRES Timing

Characteristics	Crawle of	M	lin.	Тур.		Max.		Unit	
Characteristics	Symbol	24bit	8bit	24bit	8bit	24bit	8bit	Omi	
DOTCLK Frequency	fDOTCLK	-		7.5	19.5	10	30	MHz	
DOTCLK Period	tDOTCLK	100	33.3	133	51.3	-	-	ns	
Vertical Sync Setup Time	tvsys	20	10	-	-	-	-	ns	
Vertical Sync Hold Time	tvsyh	20	10	-	-	-	-	ns	
Horizontal Sync Setup Time	thsys	20	10	-	-	-	-	ns	
Horizontal Sync Hold Time	thsyh	20	10	-	-	-	-	ns	
Phase difference of Sync	thv					240		tDOTCLK	
Signal Falling Edge	mv		1		-	2-	+0	DOTCLE	
DOTCLK Low Period	tCKL	50	15	-	-	-	-	ns	
DOTCLK High Period	tCKH	50	15	-	-	-	-	ns	
Data Setup Time	tds	12	8	-	-	-	-	ns	
Data hold Time	tdh	12	8	-	-	-	-	ns	
Reset pulse width	tRES	1	.0		-	-		us	

Note: External clock source must be provided to DOTCLK pin of HX8238-A. The driver will not operate if absent of the clocking signal.

Table 13. 1 Pixel & tRES Timing



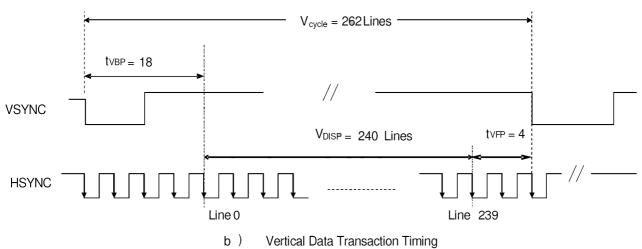


Figure 13. 3 Data Transaction Timing in Parallel RGB (24 bit) Interface (SYNC Mode)

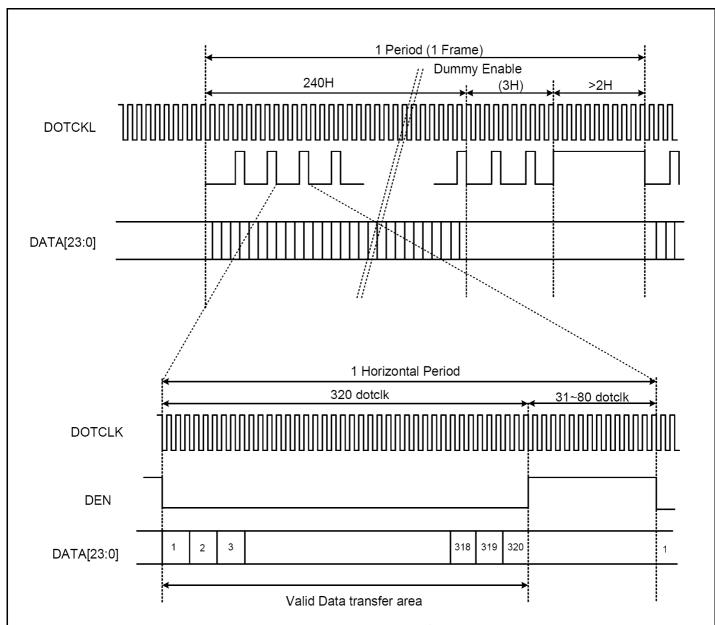
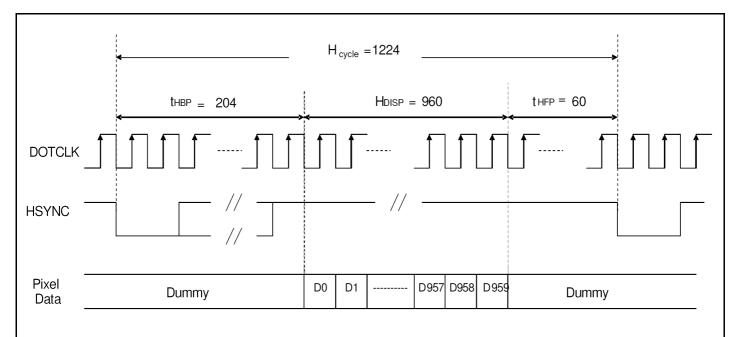


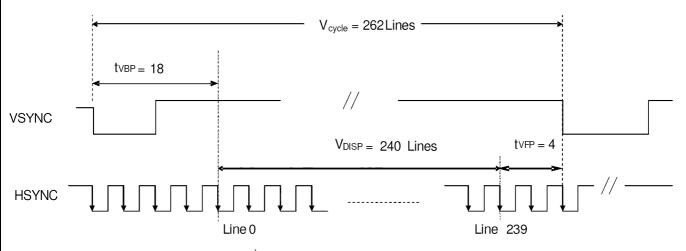
Figure 13. 4 Data Transaction Timing in Parallel RGB (24 bit) Interface (DE Mode)

Characteristics		Cranch of	M	Min		Тур		lax	Unit
		Symbol	24bit	8 bit	24bit	8 bit	24bit	8 bit	Omi
DOTCLK Frequency		fDOTCLK	-	-	7.5	19.5	10	30	MHz
DOTCLK Period		tDOTCLK	100	33.3	133	51.3	-	-	ns
Horizontal Frequency (Line)	fH		-	18.37		22.35		KHz
Vertical Frequency (Re	fresh)	fV		-	7	'0	ç	90	Hz
Horizontal Back Porch		tHBP	-	-	68	204	-	-	tDOTCLK
Horizontal Front Porch		tHFP	-	-	20	60	-	-	tDOTCLK
Horizontal Data Start P	oint	tHBP	-	-	68	204	-	-	tDOTCLK
Horizontal Blanking Period		tHBP + tHFP	-	-	88	264	-	-	tDOTCLK
Horizontal Display Area		HDISP	-	-	320	960	-	-	tDOTCLK
Horizontal Cycle		Hcycle	-	-	408	1224	450	1350	tDOTCLK
Vertical Back Porch	Vertical Back Porch		-		1	8	-		Lines
Vertical Front Porch		tVFP	-		4		-		Lines
Vertical Data Start Poir	nt	tVBP	-		18		-		Lines
Vertical Blanking Perio	Vertical Blanking Period		-		22		-		Lines
	NTSC				2	240			
Vertical Display Area	PAL	VDISP	-		280(PALM=0) 288(PALM=1)		-		Lines
	PAL								
Westing Cont.	NTSC	W1-		-	2	62		50	T in a
Vertical Cycle	PAL	Vcycle			3	13	350		Lines

Table 13. 2 Data Transaction Timing in Normal Operating Mode



a) Horizontal Data Transaction Timing



b) Vertical Data Transaction Timing

Figure 13. 5 Data Transaction Timing in Serial RGB (8 bit) Interface (SYNC Mode)

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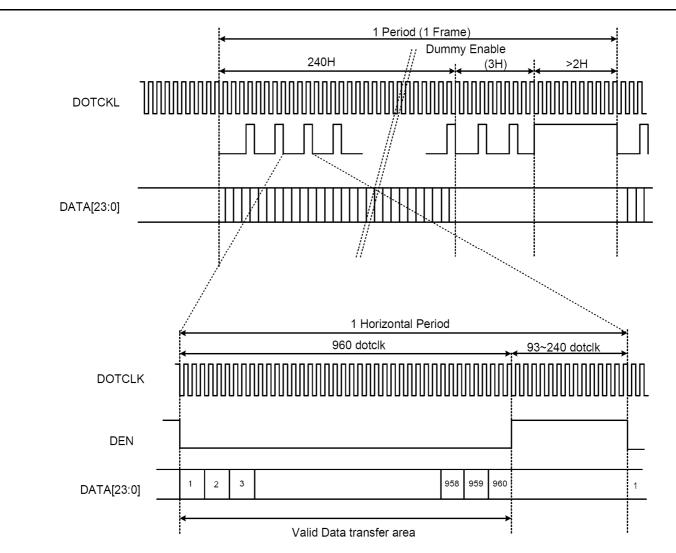
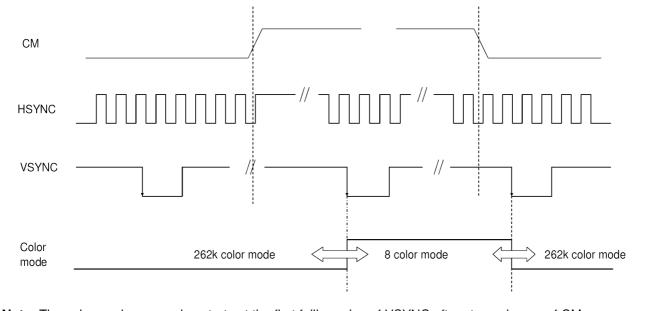


Figure 13. 6 Data Transaction Timing in Serial RGB (8 bit) Interface (DE Mode)



Note: The color mode conversion starts at the first falling edge of VSYNC after stage change of CM.

Figure 13. 7 Color Mode Conversion Timing

2.4.2 CCIR601 Timing

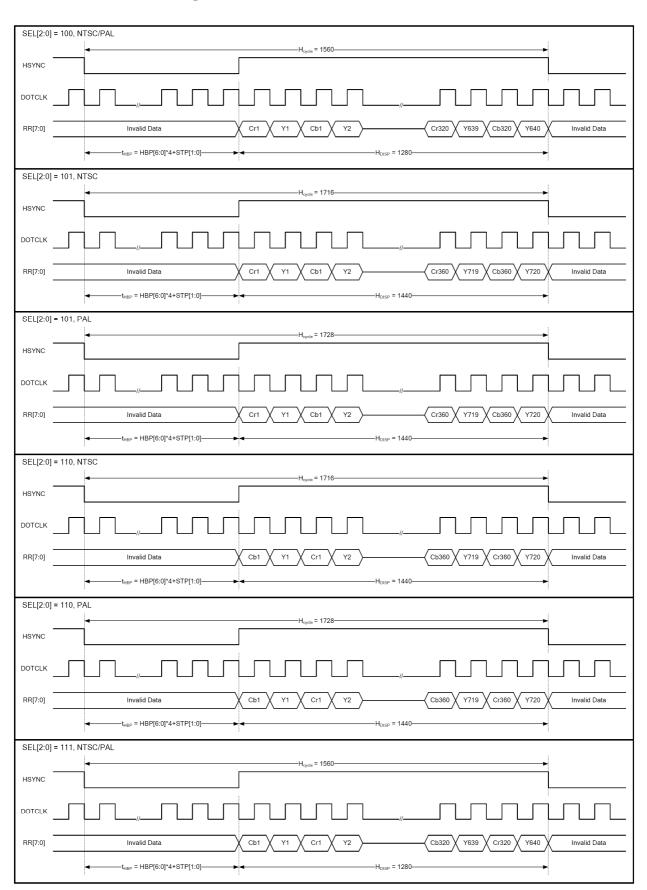
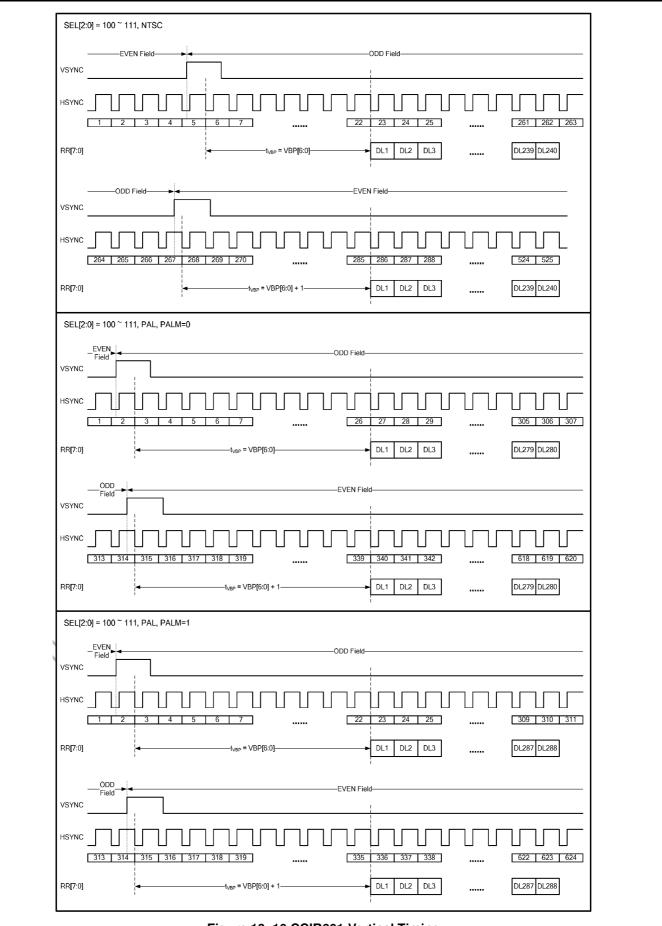


Figure 13. 9 CCIR601 Horizontal Timing



2.4.3 CCIR656 Timing

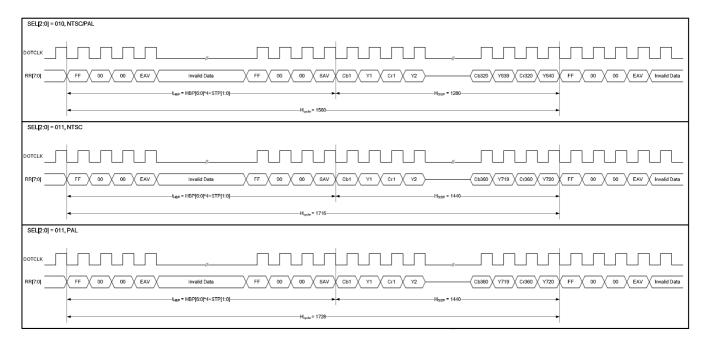


Figure 13. 11 CCIR656 Horizontal Timing

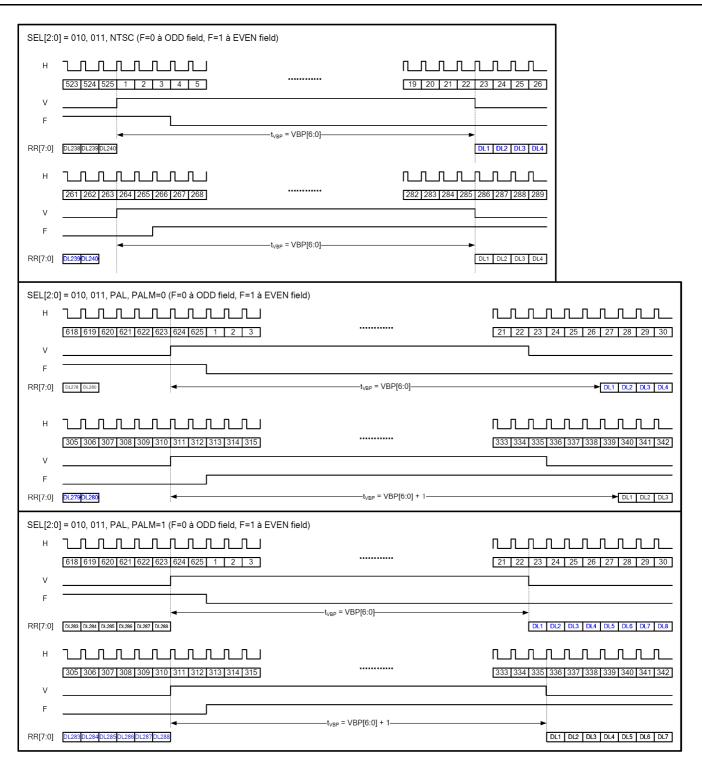
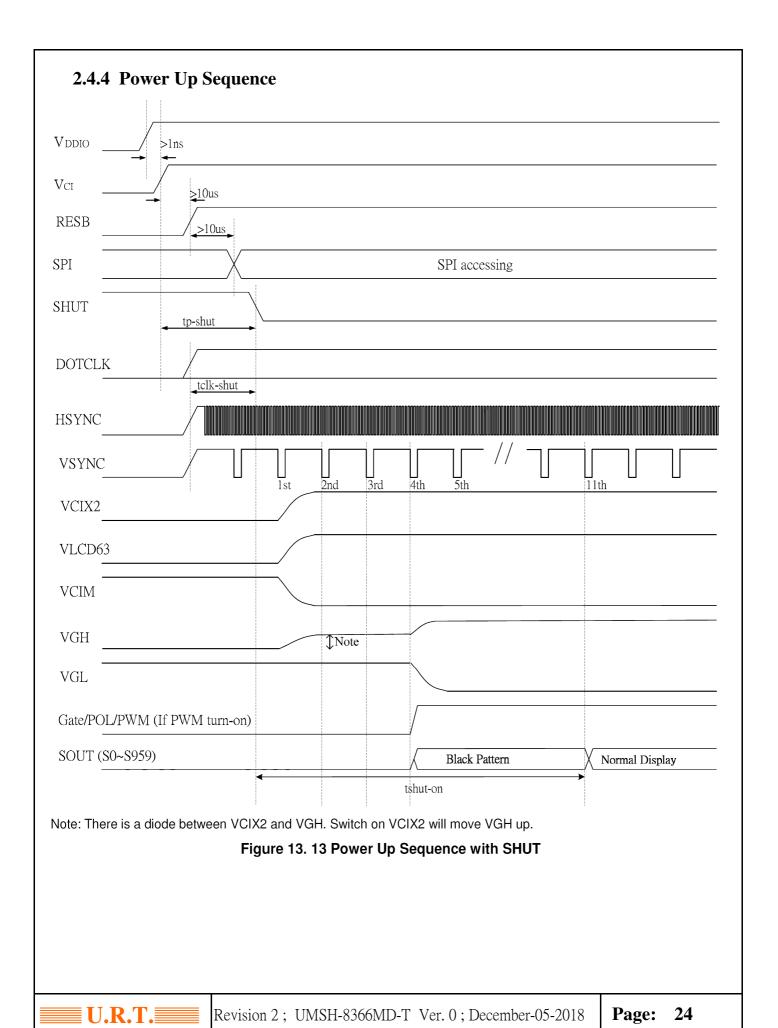


Figure 13. 12 CCIR656 Vertical Timing

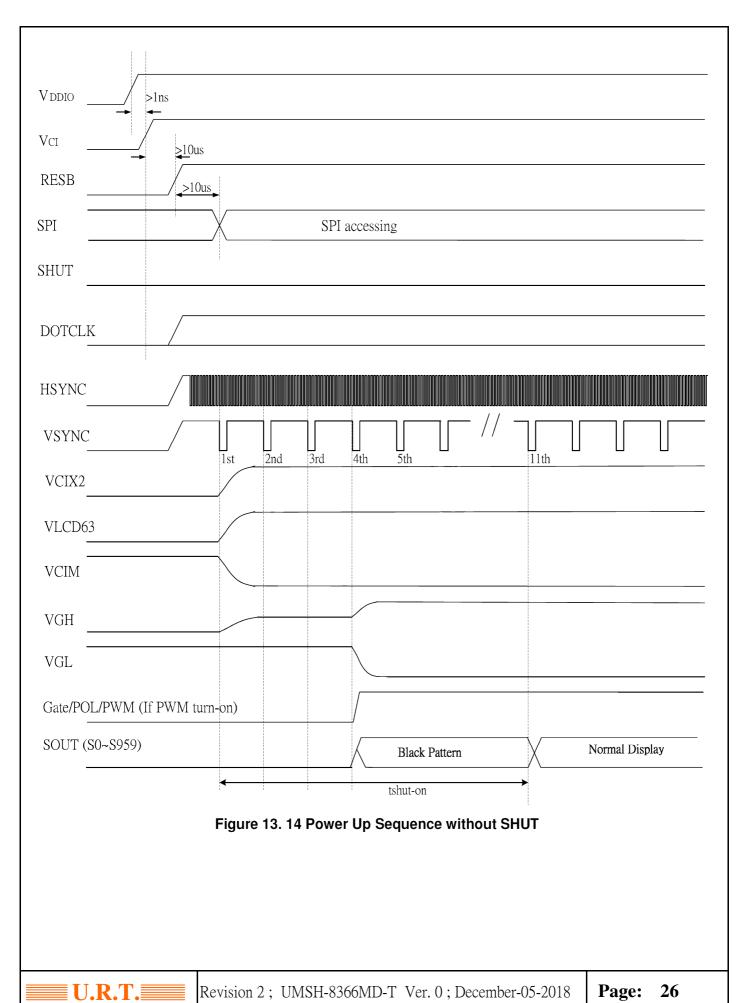


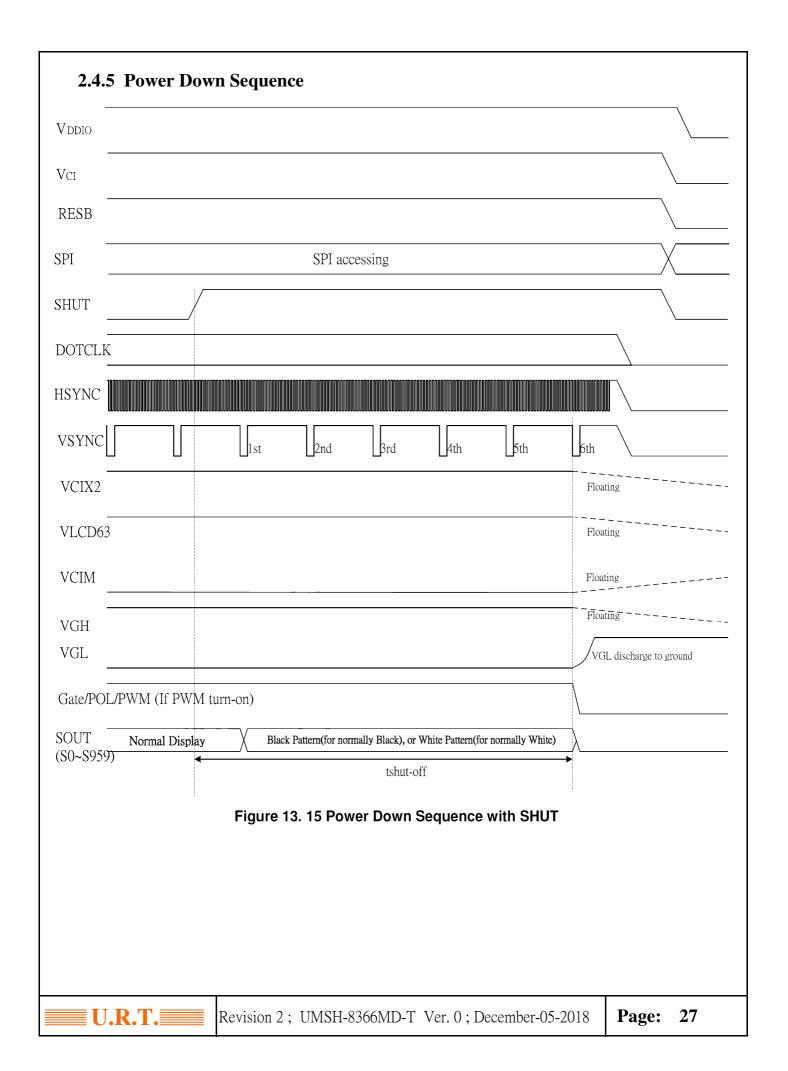
Characteristics	Symbol	Min	Тур	Max	Units
VCI/VDDIO on to falling edge of SHUT	tp-shut	1	-	-	us
DOTCLK	tclk-shut (Note1)	1	-	-	c i k
Falling edge of SHUT to display start -1 line: 408 clk -1 frame: 262 line -DOTCLK = 7.5MHz	tshut-on (Note2)	-	-	11	frame

Table 13. 3 Power Up Sequence

Note 1: It is necessary to input DOTCLK before the falling edge of SHUT.

Note2: Display starts at 11th falling edge of VSTNC after the falling edge of SHUT. The display starts at the falling edge of VSYNC which is determined by BLT[1:0] of R04h.





Characteristics	Symbol	Min	Тур	Мах	Uni
Rising edge of SHUT to display off					
-1 line: 408 clk					
-1 frame: 262 line	tshut-off	-	-	0	frame
-DOTCLK = 7.5MHz					

Note: DOTCLK must be maintained at lease 6 frames after the rising edge of SHUT.

Display become off at the 6nd falling edge of VSTNC after the falling edge of SHUT.

If RESET signal is necessary for power down, provide it after the 6-frames-cycle of the SHUT period.

Table 13. 4 Power Down Sequence

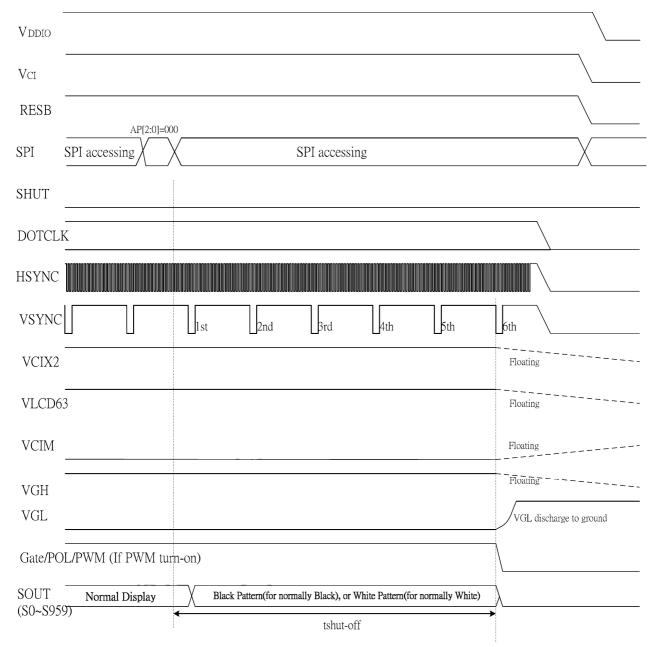
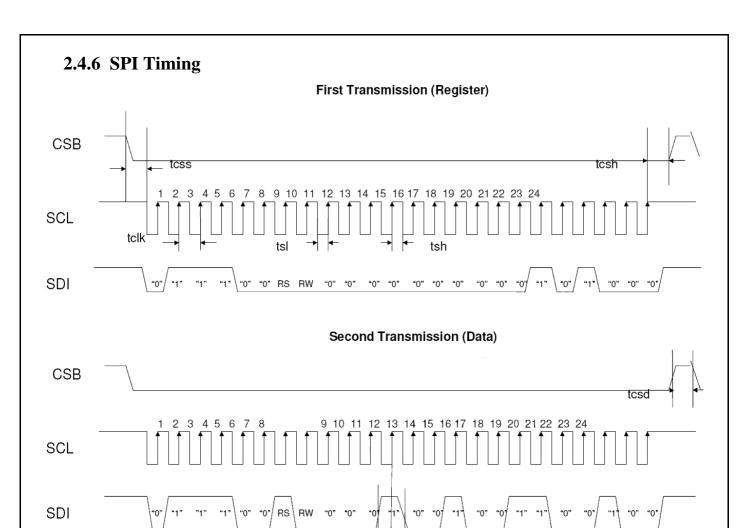


Figure 13. 16 Power Down Sequence without SHUT



Note: The example transmit "0x1264h" to register R28h. SPID connected to VSS.

Figure 14. 12 SPI interface Timing Diagram & Transaction Example

tdh

tds

Characteristics	Symbol	Min	Тур	Max	Unit
Serial C ock Frequency	fclk	-	-	20	MHz
Serial Clock Cycle Time	tclk	50	-	-	ns
Clock Low Width	tsl	25	-	-	ns
Clock High Width	tsh	25	-	-	ns
Chip Select Setup Time	tcss	0	-	-	ns
Chip Select Hold Time	tcsh	10	-	-	ns
Chip Select High Delay Time	tcsd	20	-	-	ns
Data Setup Time	tds	5	-	-	ns
Data Hold Time	tdh	10	-	-	ns

Table 14. 5 SPI Timing

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$\textbf{2.4.7} \;\; \textbf{Command} \; \textbf{(Recommend by U.R.T.)}$

LCD_Initial_HX-8238:

COMMAND	CODE	DESCRIPTION
R02H	0200	LCD-Driving-Waveform Control
R03H	6364	Power control 1
R04H	0440	Input Data and Color Filter Control
R0DH	3221	Power Control 2
R0EH	3100	Power Control 3

Adjust the Gamma Curve:

COMMAND	CODE	DESCRIPTION
R30H	0000	Gamma Control 1
R31H	0407	Gamma Control 1
R32H	0202	Gamma Control 1
R33H	0000	Gamma Control 1
R34H	0505	Gamma Control 1
R36H	0707	Gamma Control 1
R37H	0000	Gamma Control 1
R3AH	0904	Gamma Control 2
R3BH	0904	Gamma Control 2

3. OPTICAL CHARACTERISTICS

3.1 Characteristics

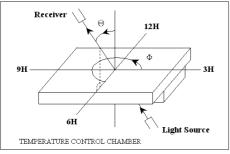
Electrical and Optical Characteristics

No.	Item				symb	ool / temp.	Min.	Тур.	Max.	Unit	Note
1	Response	Response Time			Tr	25	ı	15	20	ms	2
					Tf	25	ı	35	50	1115	2
		Hor.			θ_{2^+}	$\Phi = 0$ °	60	75	1		
2	Viewing	1101.	Cr	10	θ_{2}	$\Phi = 180^{\circ}$	60	75	1	dagraa	3
	Angle	Ver.	CI	10	θ_{1+}	$\Phi = 270^{\circ}$	45	60	ı	degree	3
		V CI.			θ_{1}	$\Phi = 90^{\circ}$	60	75	1		
3	Contrast	Ratio			Cr	25	400	600	ı	-	4
	Red x-co	de			Rx		0.58	0.63	0.68		
	Red y-code		Ry		0.31	0.36	0.41				
	Green x-c	code			Gx		0.29	0.34	0.39		
	Green y-code		Gy		0.54	0.59	0.64		5		
4	Blue x-co	ode			Bx	25	0.09	0.14	0.19	-	
	Blue y-co	ode			Ву		0.04	0.09	0.14		
	White x-o	White x-code			Wx		0.28	0.33	0.38		
	White y-c	code			Wy		0.29	0.34	0.39		
	Brightnes	SS			Y		500	700	ı	cd/m ²	
5	Brightnes Uniform					25	80	-	-	%	6

3.2 Definition of optical characteristics

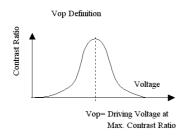
Measurement condition:

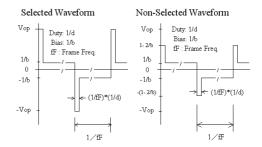
Transmissive and Transflective type



PHOTAL LCD-5000

[Note 1] Definition of LCD Driving Vop and Waveform :





[Note 2] Definition of Response Time

for Positive type :

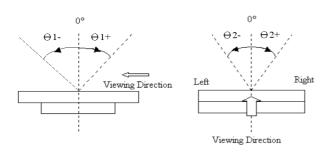
Selected State Non-Selected State

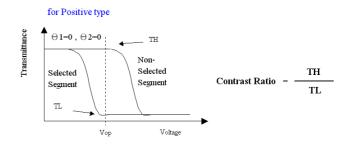
90% 90% -

Selected State

[Note 3] Definition of Viewing Angle:

[Note 4] Definition of Contrast Ratio:



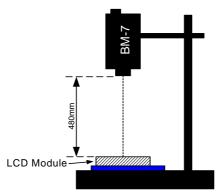


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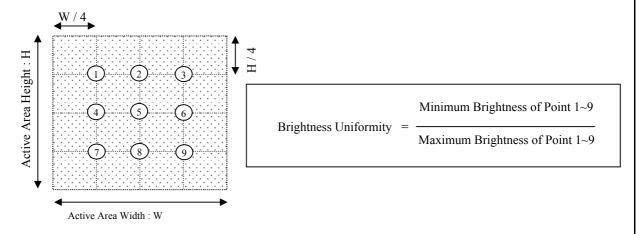


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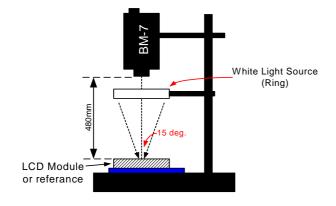
[Note 5] Definition of measurement of Color Chromaticity and Brightness



[Note 6] Definition of Brightness Uniformity



[Note 7] Definition of Measurement of Reflectance



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4. RELIABILITY:

Item No	Items	Condition	Note
1	High temperature operating	85 , 200 hours	1
2	Low temperature operating	-30 , 200 hours	1
3	High temperature storage	90 , 200 hours	1
4	Low temperature storage	-40 , 200 hours	1
5	High temperature & humidity	60 , 90%RH, 100 hours	2
6	Thermal Shock storage	-40 , 30min.<=> 90 , 30min. 10 Cycles	1
7	Vibration test	10 => 55 => 10 => 55 => 10 Hz, within 1 minute Amplitude: 1.5mm. 15 minutes for each Direction (X,Y,Z)	
8	Drop test	Packed, 100CM free fall, 6 sides, 1 corner, 3edges	
9	Life time	50,000 hours 25 , 60%RH , specification condition driving	

- Note 1: The product move into the room temperature for at least 2 hours with no condensation.
- Note 2: The product move into the room temperature for at least 24 hours with no condensation.
- Note 3: Please change the display picture (autorun) during operating mode. Avoid displaying static images
 - * One single product test for only one item.
 - * Judgment after test: keep in room temperature for more than 2 hours.
 - Current consumption < 2 times of initial value
 - Contrast > 1/2 initial value
 - Function : work normally

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5. PRODUCT HANDLING AND APPLICATION

PRECAUTION FOR HANDLING LCM

The LCD module contains a C-MOS LSI. People who operate the LCM should wear

ESD protection eguipement to prevent ESD hurt on products.

Do not input any signal before power is turned on.

Do not take LCM from its packaging bag until it is assembled.

Peel off the LCM protective film slowly since static electricity may be generated.

Pay attention to the humidity of the work shop, 50~60%RH is satisfactory.

Use a non-leak iron for soldering LCM.

Do not touch the display surface or connection terminals area with bare hands. Smudges on the display surface reduce the insulation between terminals.

Cautions for soldering to LCM:

Condition for soldering I/O terminals:

Temperature at iron tip: 350 ± 15 .

Soldering time: 3~4sec./ terminals.

Type of solder: Eutectic solder(rosin flux filled).

PRECAUTION IN USE OF LCD

Do not contact or scratch the front surface and the contact pads of a LCD panel with hard materials such as metal or glass or with one's nail.

To clean the surface, wipe it gently with soft cloth dampened by alcohol.

Do not attempt to wiped off the contact pads.

Keep LCD panels away from direct sunlight, also avoid them in high-temperature & high humidity environment for a long period.

Do not drive LCD panels by DC voltage.

Do not expose LCD panels to organic solvent.

Liquid in LCD is hazardous substance. In case a contact with liquid crystal material is occured, be sure to immediately wash such material away by soap and water.

The polarizer is easily damaged and should be handle with special care. Don't press or rub it with hard objects.

PRECAUTION FOR STORING AND USE OF LCM

To avoid degradation of the device , do not store the module under the conditions of direct sunlight , high temperature or high humidity . Keep the module in bags designed to prevent static electricity charging under low temperature / normal humidity conditions(avoid high temperature / high humidity and low temperature below 0)

Never use the LCD , LCM under $45~\mathrm{Hz}$, the liquid crystal will decomposition and cause permently damage on display !!

USING ON MEDICAL CARE, SAFETY OR HAZARDOUS APPLICATION OR SYSTEM

For the application in medical care, safety and hazardous products or systems, an authorization from URT is required. URT will not responsible for any damage or loss which caused by the products without any authorization given by URT.

This product is not allowed to be designed and used for military application and/or purpose.

The delivery of this product to the countries and/or regions where the embargoes are imposed by U.N. is prohibited.

The application and delivery of this product must comply with Startegic High-Tech Commodities (SHTC) export control and the sales to the embargoed and/or sanctioned countries or regions are strictly prohibited.

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U.R.T

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6. DATE CODE OF PRODUCTS

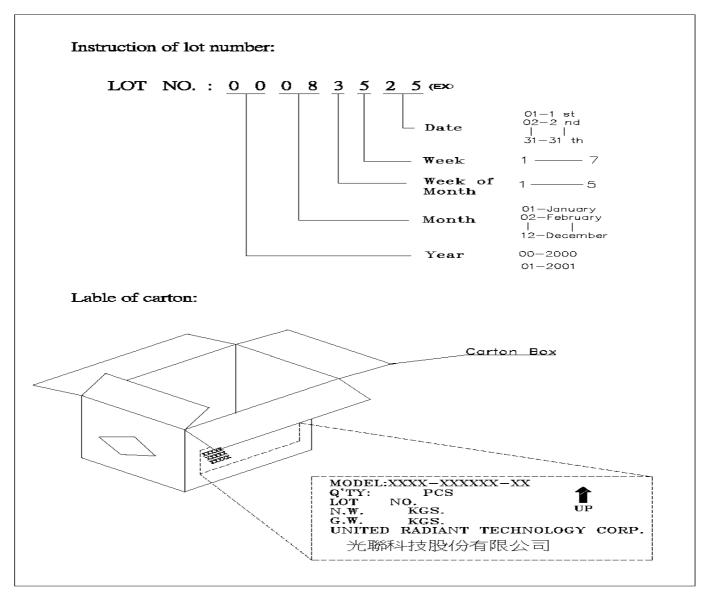
Date code will be shown on each product:

Example: 141108 - 0003 ==> Year 2014, November,8th, Serial No.0003

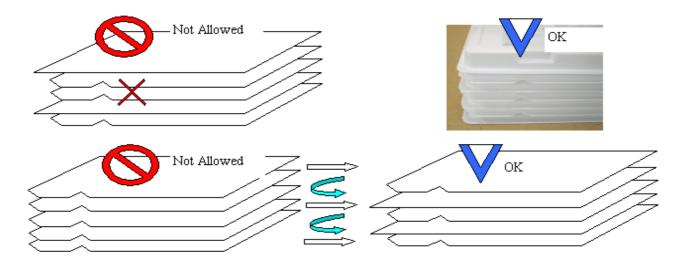
Note: The lot no. attached on the packing box will be used for tracking once the part is too small to print the date code.

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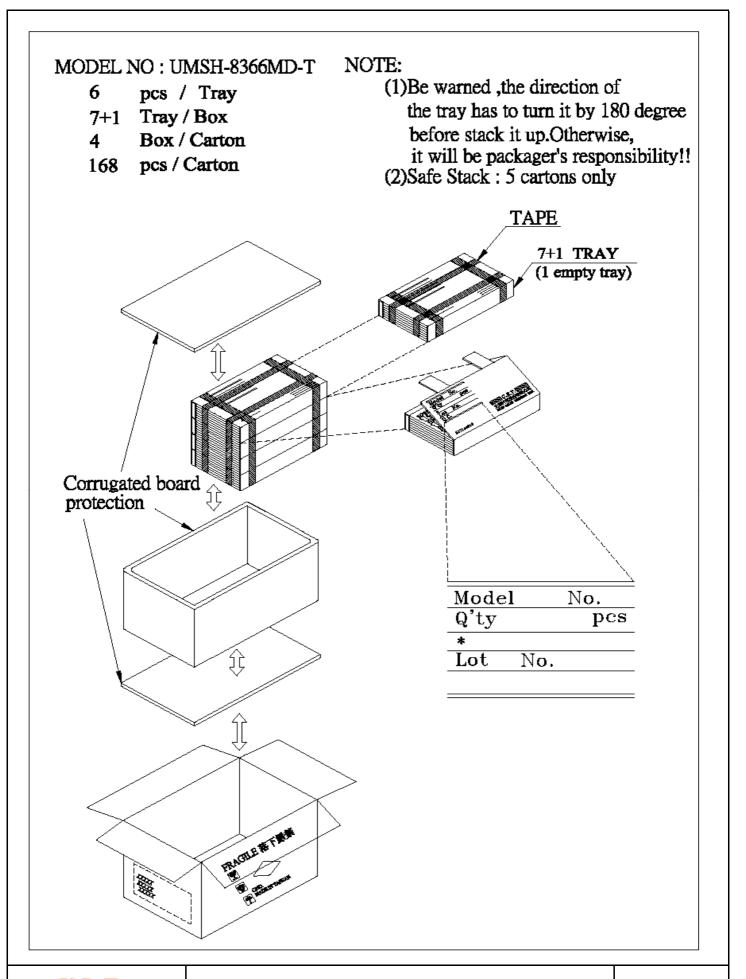
7. PACKING



Packing tray must be stacked with alternated direction to each others. To tacks packing trays in same direction will cause product damaged.



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8. INSPECTION STANDARD

8.1. QUALITY:

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD.

8.1.1. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM U.R.T. TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10 TO 40 ,AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

8.1.2. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

(B) LINEAR TYPE:

IF PURCHASER MAKE AN INCOMING INSPECTION, A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (or MIL-STD-105E), LEVEL SINGLE PLAN.

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %
TOTAL	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION , A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

8.1.3. WARRANTY POLICY

U.R.T. WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. U.R.T. WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF U.R.T.

8.2. CHECKING CONDITION

- **8.2.1.** CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.
- **8.2.2.** CHECKER SHALL SEE OVER 30 cm. WITH BARE EYES FAR FROM SAMPLE AND USING 2 PCS. OF 20W FLUORESCENT LAMP.

U.R.T

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8.3. INSPECTION PLAN:

CLASS	ITEM	JUDGEMENT	CLASS
	1. OUTSIDE AND INSIDE PACKAGE	"MODEL NO.", "LOT NO." AND "QUANTITY"	Minor
PACKING &		SHOULD INDICATE ON THE PACKAGE.	
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED	Critical
		QUANTITY SHORT OR OVERREJECTED	
	3. PRODUCT INDICATION	(B) LINEAR TYPE:	Major
		THE PRODUCT	
	4. DIMENSION,	ACCORDING TO SPECIFICATION OR	
ASSEMBLY	LCD GLASS SCRATCH	DRAWING.	Major
	AND SCRIBE DEFECT.		1.14901
	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE	Minor
	or viz with a ringer	IS VISABLE IN THE VIEWING AREA	1,11101
		REJECTED	
	6. BLEMISH、BLACK SPOT、	ACCORDING TO STANDARD OF VISUAL	Minor
	WHITE SPOT IN THE LCD	INSPECTION (INSIDE VIEWING AREA)	WIIIOI
	AND LCD GLASS CRACKS	INSPECTION (INSIDE VIEWING AREA)	
		ACCORDING TO STANDARD OF VISUAL	Minor
APPEARANCE	7. BLEMISH, BLACK SPOT	ACCORDING TO STANDARD OF VISUAL	Millor
	WHITE SPOT AND SCRATCH	INSPECTION (INSIDE VIEWING AREA)	
	ON THE POLARIZER		3.6
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL	Minor
		INSPECTION (INSIDE VIEWING AREA)	
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR (OR NEWTON	
		RING) OF LCDREJECTED.	Minor
		OR ACCORDING TO LIMITED SAMPLE	
		(IF NEEDED, AND INSIDE VIEWING AREA)	
	10. ELECTRICAL AND OPTICAL	ACCORDING TO SPECIFICATION OR	Critical
	CHARACTERISTICS	DRAWING . (INSIDE VIEWING AREA)	
	(CONTRAST, VOP,		
	CHROMATICITY ETC)		
ELECTRICAL	11.MISSING LINE	MISSING DOT, LINE, CHARACTER	Critical
		REJECTED	
	12.SHORT CIRCUIT、	NO DISPLAY、WRONG PATTERN	Critical
	WRONG PATTERN DISPLAY	DISPLAY、CURRENT CONSUMPTION	
		OUT OF SPECIFICATION REJECTED	
	13. DOT DEFECT (FOR COLOR AND TFT)	ACCORDING TO STANDARD OF VISUAL	Minor
	Í	INSPECTION	

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8.4. STANDARD OF VISUAL INSPECTION

0.1 0.1 0.25	unit : mm. CCEPTABLE Q'TY DISREGARD 3 (D>5mm) 0 2 unit : mm. ACCEPTABLE Q'TY 0.03 DISREGARD 0.07 3 (D>5mm) FOLLOW ROUND TYPE unit : mm. ACCEPTABLE Q'TY DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm) N 4 (D>5mm)
0.1	DISREGARD 3 (D>5mm) 0 2 unit : mm. ACCEPTABLE Q'TY 0.03 DISREGARD 0.07 3 (D>5mm) FOLLOW ROUND TYPE unit : mm. ACCEPTABLE Q'TY DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
0.1 < 0.25 0.25 <	3 (D>5mm) 0 2 unit : mm. ACCEPTABLE Q'TY 0.03 DISREGARD 0.07 3 (D>5mm) FOLLOW ROUND TYPE unit : mm. ACCEPTABLE Q'TY DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
0.25 <	0 2 unit: mm. ACCEPTABLE Q'TY 0.03 DISREGARD 0.07 3 (D>5mm) FOLLOW ROUND TYPE unit: mm. ACCEPTABLE Q'TY DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
NOTE: =(LENGTH+WIDTH)/2 (B) LINEAR TYPE: LENGTH WIDTH	Unit : mm.
(B) LINEAR TYPE: LENGTH	unit:mm. ACCEPTABLE Q'TY 0.03 DISREGARD 0.07 3 (D>5mm) FOLLOW ROUND TYPE unit:mm. ACCEPTABLE Q'TY DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
LENGTH WIDTH	ACCEPTABLE Q'TY 0.03 DISREGARD 0.07 3 (D>5mm) FOLLOW ROUND TYPE unit: mm. ACCEPTABLE Q'TY DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
DIAMETER 0.2 0.2 < 0.5 0.5 < Items Bright dot Dark dot	0.03 DISREGARD 0.07 3 (D>5mm) FOLLOW ROUND TYPE unit: mm. ACCEPTABLE Q'TY DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
L 5.0 0.03 < W 0.07 < W	0.07 3 (D>5mm) FOLLOW ROUND TYPE unit: mm. ACCEPTABLE Q'TY DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
DIAMETER 0.2 0.2 < 0.5 0.5 < Items Bright dot Dark dot	unit : mm. ACCEPTABLE Q'TY DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
DIAMETER	unit : mm. ACCEPTABLE Q'TY DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
0.2	ACCEPTABLE Q'TY DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
0.2	ACCEPTABLE Q'TY DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
0.2	DISREGARD 2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
0.2 < 0.5 0.5 < Items Bright dot Dark dot	2 (D>5mm) 0 ACC. Q'TY N 4 (D>5mm)
0.5 < Items Bright dot Dark dot	0 ACC. Q'TY N 4 (D>5mm)
Items Bright dot Dark dot	ACC. Q'TY N 4 (D>5mm)
Bright dot Dark dot	N 4 (D>5mm)
<u> </u>	N 4 (D>5mm)
Pixel Define	
Pixel R G ◆ Dot → ◆ Dot →	B ← Dot →
Not 1: The definition of dot: Th	
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NO.	CLASS	ITEM	JUDGEMENT	Γ
8.4.4	MINOR	LCD GLASS CHIPPING	Š V	Y > S Reject
8.4.5	MINOR	LCD GLASS CHIPPING	SXX	X or Y > S Reject
8.4.6	MAJOR	LCD GLASS GLASS CRACK	T	Y > (1/2) T Reject
8.4.7	MAJOR	LCD GLASS SCRIBE DEFECT	$A_{\uparrow}^{\downarrow} = A_{\uparrow} + B$	 a> L/3 , A>1.5mm. Reject B: ACCORDING TO DIMENSION
8.4.8	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL AREA)	T	= (x+y)/2 > 3.0 mm Reject
8.4.9	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL SURFACE)	T Z X	Y > (1/3) T Reject
8.4.10	MINOR	LCD GLASS CHIPPING	T Z	Y > T Reject